UMW 30N06

60V N-Channel MOSFET

1.Description

These N-channel enhancement mode power mosfets used advanced trench technology design, provided excellent Rdson and low gate charge. Which accords with the RoHS standard.

2.1Features

- $V_{DS\ (V)}$=60V
- I_D=35A(V_{GS}=10V)
- $R_{DS(ON)}$<23mΩ(V_{GS}=10V)
- $R_{DS(ON)}$<30mΩ(V_{GS}=4.5V)

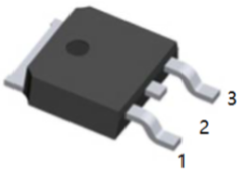
2.2Features

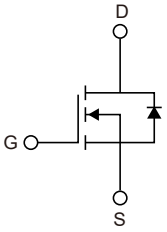
- Fast Switching
- Low ON Resistance(Rdson≤29mΩ)
  Low Gate Charge
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

3.Pinning information

Pin	Symbol	Description
1	G	GATE
3	S	SOURCE
2	D	DRAIN

TO-252(DPAK)
top view





4.Absolute Maximum Ratings T_A= 25°C

Parameter		Symbol	Rating	Units
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current	T_C=25°C	I_D	35	A
	T_C=100°C		24.5	
Pulsed Drain Current [1]		I_{DM}	100	
Single Puise Avalanche Energy [2]		E_{AS}	56.2	mJ
Maximum Power Dissipation	T_C=25°C	P_D	36.2	W
Storage Temperature Range		T_{STG}	-55 to 150	°C
Operating Junction Temperature Range		T_J	-55 to 150	°C

5.Thermal resist ance rating

Parameter	Symbol	Typ	Max	Units
Thermal Resistance,Junction-to-Case	$R_{\theta JC}$		3.45	°C/W
Thermal Resistance,Junction to Ambient	$R_{\theta JA}$		111.5	°C/W

6.SPECIFICATIONS (T_J= 25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_{DS}=250μA	60			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=60V, V_{GS}=0V			1	μA
Gate-Body Leakage	I_{GSS}	V_{GS}=±20V, V_{DS}=0V			±100	nA
ON CHARACTERISTIC						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_{DS}=250μA	1	1.5	2	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_{DS}=19A		23	29	mΩ
		V_{GS}=4.5V, I_{DS}=19A		30	38	mΩ
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	V_{DS}=30V, V_{GS}=0V, f=1MHz		939		pF
Output Capacitance	C_{oss}			73.5		pF
Reverse Transfer Capacitance	C_{rss}			52.7		pF
Gate Resisitance	R_g	V_{DD}=0V, V_{GS}=0V, f=1MHz		1.9		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$t_{D(on)}$	V_{GS}=10V, V_{DS}=30V R_{GEN}=3Ω, I_D=20A		8.4		ns
Rise Time	t_r			8.5		ns
Turn-Off Delay Time	$t_{D(off)}$			35.4		ns
Fall Time	t_f			4.8		ns
Total Gate Charge at 10V	Q_g	V_{DS}=30V, I_{DS}=20A, V_{GS}=10V		21.2		nC
Gate to Source Gate Charge	Q_{gs}			3.6		nC
Gate to Drain“Miller”Charge	Q_{gd}			5.5		nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Drain-Source Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_{DS}=20A			1.2	V
Reverse Recovery Time	t_{rr}	T_J=25°C, I_F=20A		18.8		nS
Reverse Recovery Charge	Q_{rr}	dI/dt=100A/μs		13.4		uC

Notes:

1) Repetitive rating; pulse width limited by maximum junction temperature .

2) L=0.5mH,V_{DD}=30V,I_{as}=15A Start T_J=25°C.

3) Recommend soldering temperature defined by IPC/JEDEC J-STD 020.

7.1Typical Characterisitics

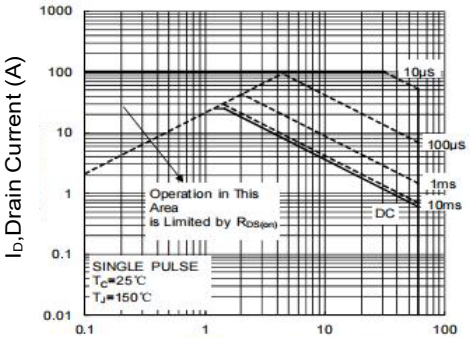


Figure 1: Maximum Safe Operating Area

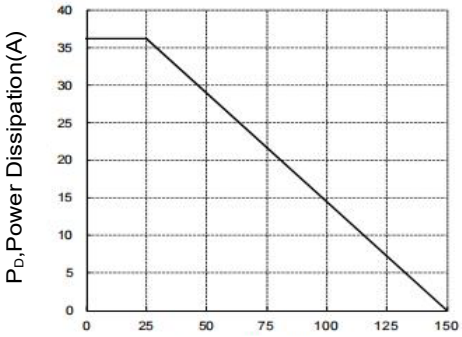


Figure 2: Maximum Power Dissipation vs Case Temperature

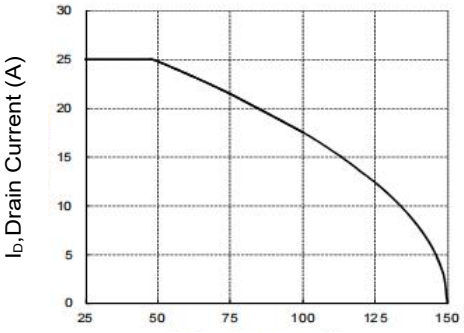


Figure 3: Maximum Power Dissipation vs Case Temperature

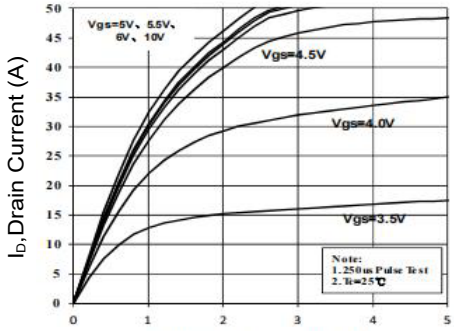


Figure 4: Typical output Characteristics

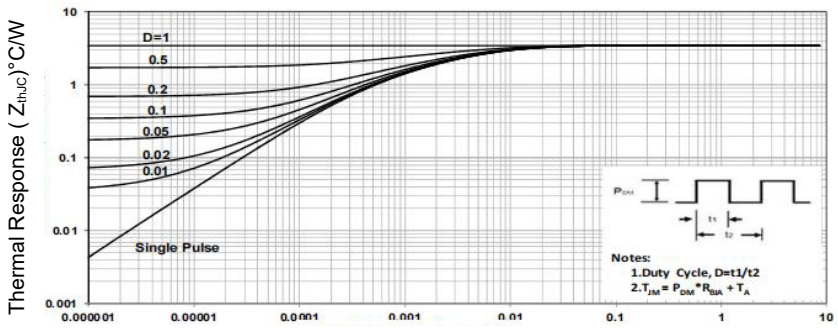
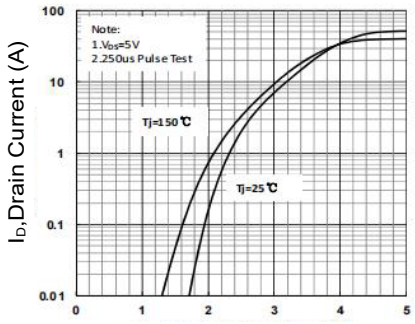


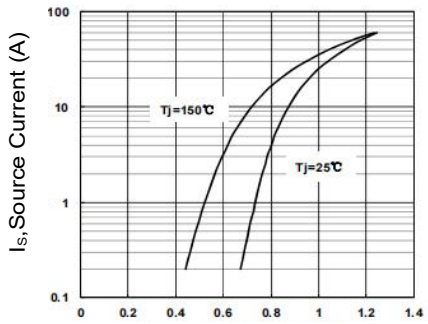
Figure 5: Maximum Effective Transient Thermal Impedance, Junction-to-Case

7.2Typical Characterisitics



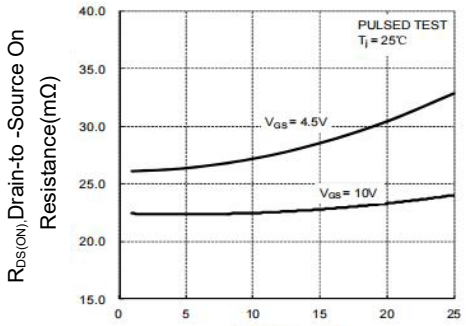
V_{GS},Gate-to-Source Voltage (V)

Figure 6: TypicalTransfer Characteristics



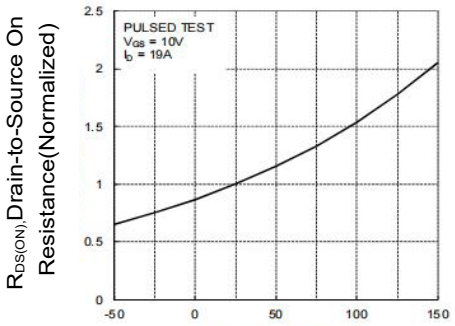
V_{SD},Source-to-Drain Voltage (V)

Figure 7: Typical Body Diode TransferCharacteristics



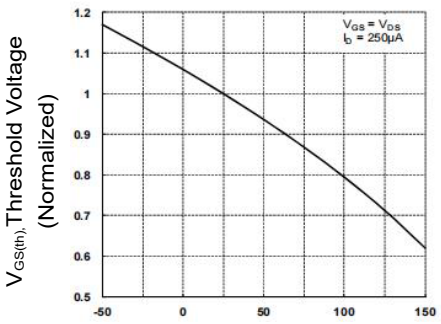
I_D,Drain Current (A)

Figure 8: Drain-to-Source On Resistance vs Drain Curent



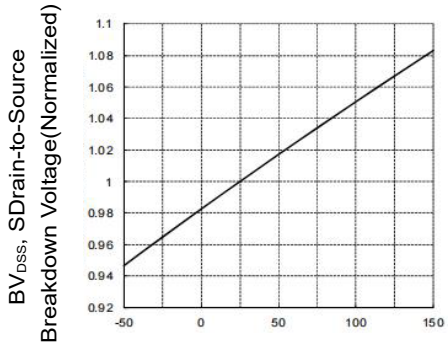
T_J,Junction Temperature(°C)

Figure 9: Normalized On Resistance Junction Temperature



T_J, Junction Temperature (°C)

Figure 10: Normaliz ed Threshold Voitage vs Junction Temperature



T_J, Junction Temperature (°C)

Figure 11: Normaliz ed Threshold Voitage vs Junction Temperature

7.3Typical Characterisitics

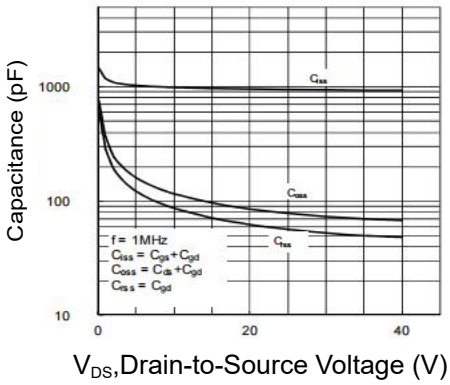


Figure 12: Capacitance Characteristics

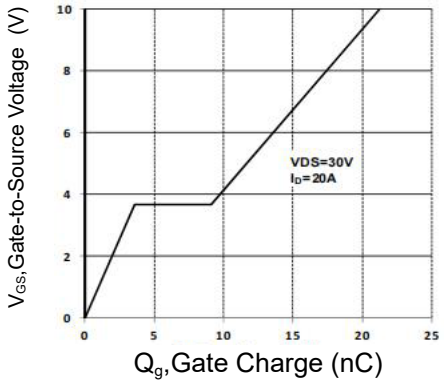


Figure 13: Typical Gate Chargevs Gate toSource Voltage

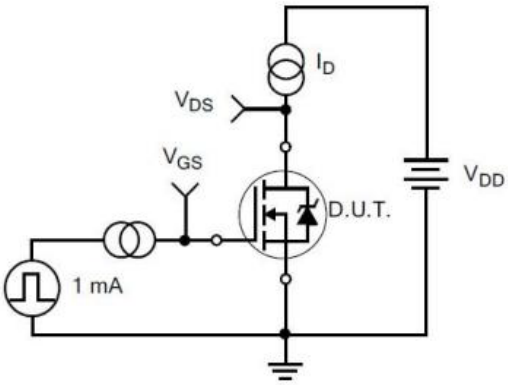


Figure 14: Gate Charge Test Circuit

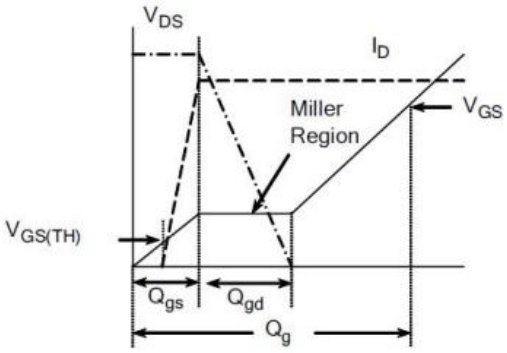


Figure 15: Gate Charge Waveforms

7.3Typical Characterisitics

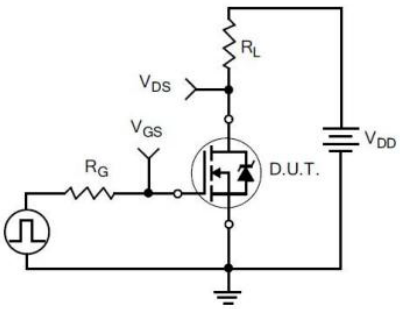


Figure 16: Resistive Switching Test Cireuit

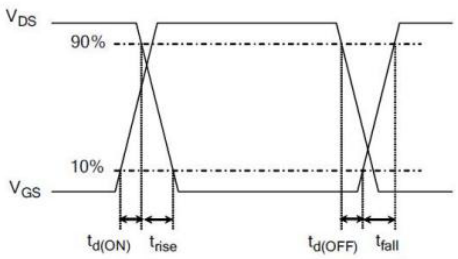


Figure 17: Resistive Switching Waveforms

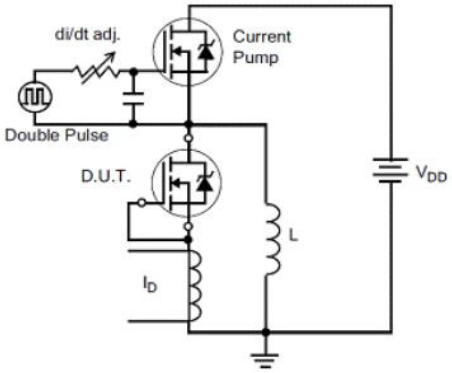


Figure 18: Diode Reverse Recovery Test Circuit

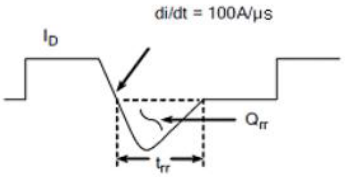


Figure 19: Diode Reverse Recovery Waveform

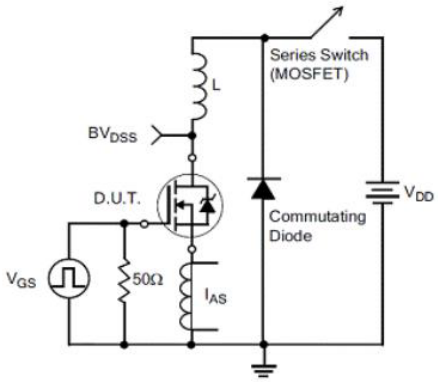


Figure 20: Uncla mped Induc tive Switehing Test Circuit

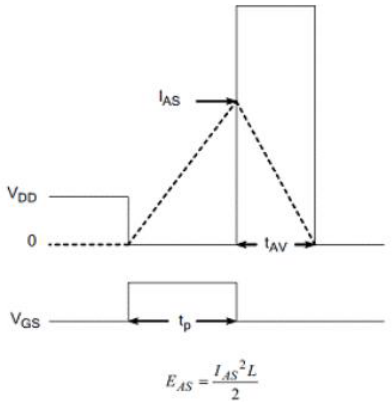
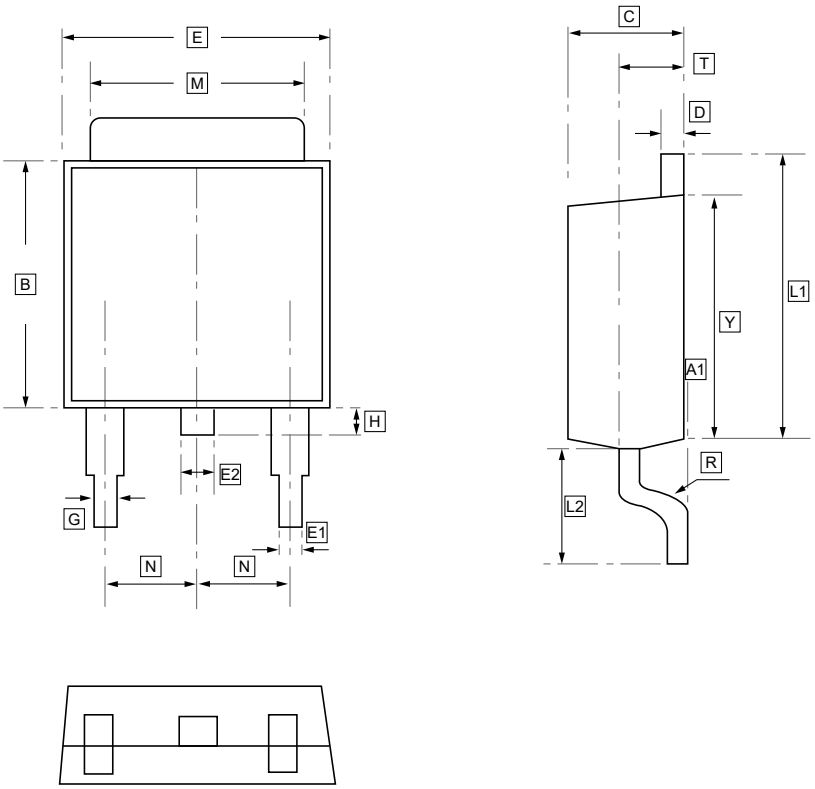


Figure : Unclamped Inductive Switching Waveform

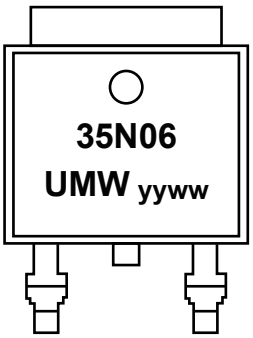
8.TO-252 PACKAGE OUTLINE DIMENSIONS



DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	B	C	D	E1	E2	F	G	L1	L2	H	M	N	R	T	Y
Min	6.30	0	5.70	2.10	0.30	0.60	0.70	0.30	0.70	9.60	2.70	0.40	5.10	2.09	0.3	1.40	5.10
Max	6.90	0.16	6.30	2.50	0.70	0.90	1.00	0.60	1.20	10.50	3.10	1.00	5.50	2.49	0.3	1.60	6.30

9.Ordering information



yy: Year Code
ww: Week Code

Order Code	Package	Base QTY	Delivery Mode
UMW 35N06	TO-252	2500	Tape and reel

10.Disclaimer

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